



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Series 508 Open Frame Socket w/Collet Contacts & Wire Wrap Pins

FEATURES

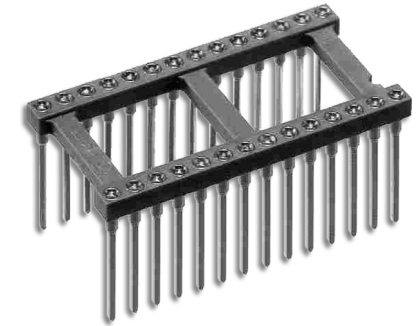
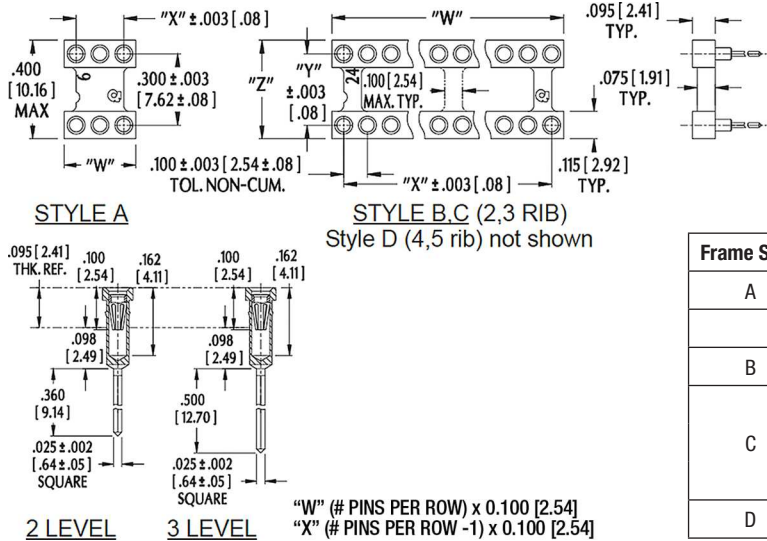
- Open Frame allows Efficient Utilization of Board Space with Optimized Cooling
- Available 2- and 3-level Wire Wrap Pins
- Compatible with Automatic Insertion Equipment
- Side-to-side and End-to-end Stackable

GENERAL SPECIFICATIONS

- **BODY MATERIAL:** Black UL 94V-0 Glass-filled 4/6 Nylon
- **PIN BODY:** Brass 360 1/2-hard per UNS C36000 ASTM B16/B16M-05
- **PIN BODY PLATING:** 10 μ [0.25 μ] min. Au per MIL-G-45204 or 200 μ [5.08 μ] min. 93/7 Sn/Pb per ASTM B545 -OR- 200 μ [5.08 μ] min. Sn per ASTM B545 Type 1 over 100 μ [2.54 μ] min. Ni per SAE AMS-QQ-N-290B
- **4-FINGER COLLET CONTACT:** BeCu per UNS C17200 ASTM B194-08
- **CONTACT PLATING:** 30 μ [0.76 μ] min. Au per MIL-G-45204 over 50 μ [1.27 μ] min. Ni per SAE AMS-QQ-N-290B
- **CONTACT CURRENT RATING:** 3 amps
- **OPERATING TEMPERATURE:** -67°F to 221°F [-55°C to 105°C] for Sn; -67°F to 257°F [-55°C to 125°C] for Au
- **INSERTION FORCE:** 180g/pin, based on 0.018 [0.46] dia. test lead
- **WITHDRAWAL FORCE:** 90g/pin, based on 0.018 [0.46] dia. test lead
- **NORMAL FORCE:** 140g/pin, based on 0.018 [0.46] dia. test lead
- **ACCEPTS LEADS:** 0.015-0.025 [0.38-0.64] dia., 0.110-0.160 [2.79-4.06] long

MOUNTING CONSIDERATIONS

- **SUGGESTED PCB HOLE SIZE:** 0.045 \pm 0.002 [1.14 \pm 0.05] dia.



ORDERING INFORMATION

XX-X 508 X XXX

- Plating**
 0 = Au Collet, Sn Shell
 OTL = Au Collet, Sn/Pb Shell
 1 = Au Collet & Shell
- Termination**
 2 = 2-level Wire Wrap
 3 = 3-level Wire Wrap
- Series**
 Row-to-Row Spacing, "Y" Dim.
 3 = 0.300 [7.62]
 4 = 0.400 [10.16]
 6 = 0.600 [15.24]
 9 = 0.900 [22.86]
- No. of Pins**
 (See Table)

Frame Style	No. of Ribs	Centers "Y"	Dim. "Z"	No. of Pins
A	1	0.300 [7.62]	0.400 [10.16]	6
		0.300 [7.62]	0.400 [10.16]	8, 14, 16, 18, 20, 24
B	2	0.400 [10.16]	0.500 [12.70]	20, 22
		0.300 [7.62]	0.400 [10.16]	28
C	3	0.400 [10.16]	0.500 [12.70]	24
		0.600 [15.24]	0.700 [17.78]	24, 28, 32, 40, 48
D	4, 5	0.900 [22.86]	1.000 [25.40]	50, 64

ALL DIMENSIONS: INCHES [MILLIMETERS]
 ALL TOLERANCES: ± 0.005 [0.13] UNLESS OTHERWISE SPECIFIED
 OPEN FRAME COLLET SOCKET w/WIRE WRAP PINS, SEE DATA SHEET 12016
 OPEN FRAME SURFACE MOUNT SOCKET, SEE DATA SHEET 12018
 OPEN FRAME COLLET CAPACITOR SOCKET w/SOLDER PIN, SEE DATA SHEET 12026
 OPEN FRAME COLLET CAPACITOR SOCKET w/WIRE WRAP, SEE DATA SHEET 12027
 CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

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